

CHT-SNMOS80 DATASHEET

Version: 2.9
14-Dec-23
(Last Modification Date)

High-Temperature Small-signal N-channel MOSFET

General description

The CHT-SNMOS-80 is a high voltage 80V N-channel small-signal MOSFET designed to achieve high performance in an extremely wide temperature range: typical operation temperature goes from -55°C to 225°C.

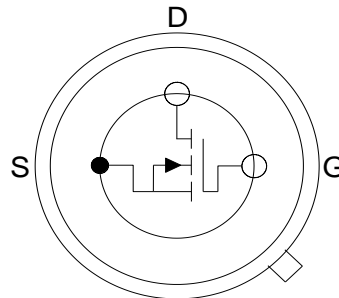
Applications

Sensor interfaces, such as piezoelectric sensor, guard amplifiers, switches of high and medium impedance loads, level-shifters and high temperature diodes.

Features

- Qualified from -55 to +225°C (Tj)
- Drain voltage up to 80V
- Typ output current 300mA @ 225°C
- $R_{DSon} = 15\Omega @ 225^\circ\text{C}$
- $V_{GS} = -0.5\text{V to } +5.5\text{V}$
- Reverse ESD diode between gate and source.
- Validated at 225°C for 1000 hours (and still on-going)
- Available in TO18 package (other packages available upon request).

Package configurations¹



TO18 (Top view) (case connected to source)

¹ Other packages available upon request.

Absolute Maximum Ratings

Gate-to-Source voltage V_{GS}	-0.5V to 5.5V
Pulsed drain current I_{DS} ($T_{pulse} \leq 2\mu s$)	500mA @ -55°C 450mA @ 25°C 300mA @ 225°C
Power dissipation $T_c=25^\circ C$	3.75W
Junction temperature T_j	300°C

Operating Conditions

Gate-to-Source voltage V_{GS}	0V to 5V
Drain-to-Source voltage V_{DS}	0V to 80V
Power dissipation $T_c=25^\circ C$	3.3W
Junction temperature	-55°C to +225°C

ESD Rating

Human Body Model	CLASS1C
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Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Frequent or extended exposure to absolute maximum rating conditions or above may affect device reliability.

Electrical characteristics

DC Characteristics

Unless otherwise stated, $T_j = 25^\circ\text{C}$. **Bold** figures point out values valid over the whole temperature range ($T_j = -55^\circ\text{C}$ to $+225^\circ\text{C}$).

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Threshold voltage	V_{TH}	$V_{DS} = 50\text{mV}$	1	1.65	1.9	V
Drain cut-off current	I_{DSS}	$V_{GS} = 0\text{V}$, $V_{DS} = 80\text{V}$, $T_j = 25^\circ\text{C}$		5		nA
		$V_{GS} = 0\text{V}$, $V_{DS} = 80\text{V}$, $T_j = 225^\circ\text{C}$		4		uA
Gate leakage current ¹	I_{GSS}	$V_{GS} = 5\text{V}$, $V_{DS} = 50\text{mV}$, $T_j = 25^\circ\text{C}$		100		pA
		$V_{GS} = 5\text{V}$, $V_{DS} = 50\text{mV}$, $T_j = 225^\circ\text{C}$		400		nA
Static drain-to-source resistance	$R_{DS(on)}$	$V_{GS} = 5\text{V}$, $V_{DS} = 50\text{mV}$, $T_j = -55^\circ\text{C}$		5.93		Ω
		$V_{GS} = 5\text{V}$, $V_{DS} = 50\text{mV}$, $T_j = 25^\circ\text{C}$		7.54		Ω
		$V_{GS} = 5\text{V}$, $V_{DS} = 50\text{mV}$, $T_j = 225^\circ\text{C}$		15.22		Ω
Breakdown drain-to-source voltage ²	V_{BRDS}	$V_{GS} = 0\text{V}$	80			V

Dynamic Characteristics

Unless otherwise stated, $T_j = 25^\circ\text{C}$. **Bold** figures point out values valid over the whole temperature range ($T_j = -55^\circ\text{C}$ to $+225^\circ\text{C}$).

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Input capacitance	C_{ISS}	$V_{GS} = 0V_{DC}$, $V_{DS} = 25V_{DC}$		23		pF
Output capacitance	C_{OSS}	$V_{GS} = 0V_{DC}$, $V_{DS} = 25V_{DC}$		8.6		pF
Feedback capacitance	C_{RSS}	$V_{GS} = 0V_{DC}$, $V_{DS} = 25V_{DC}$		1.8		pF

Switching Characteristics

Unless otherwise stated, $T_j = 25^\circ\text{C}$. **Bold** figures point out values valid over the whole temperature range ($T_j = -55^\circ\text{C}$ to $+225^\circ\text{C}$).

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Turn-on delay time	$T_{d(ON)}$	$V_{DS} = 40\text{V}$, $V_{GS} = 5\text{V}$ 1 μs pulse		20		ns
Rise time	T_r	$V_{DS} = 40\text{V}$, $V_{GS} = 5\text{V}$ 1 μs pulse		6.5		ns
Turn-off delay time	$T_{d(OFF)}$	$V_{DS} = 40\text{V}$, $V_{GS} = 5\text{V}$ 1 μs pulse		19		ns
Fall time	T_F	$V_{DS} = 40\text{V}$, $V_{GS} = 5\text{V}$ 1 μs pulse		8.1		ns
Drain current	I_D	$V_{DS} = 80\text{V}$, $V_{GS} = 5\text{V}$ 2 μs pulse, $T_j = -55^\circ\text{C}$		500		mA
		$V_{DS} = 80\text{V}$, $V_{GS} = 5\text{V}$ 2 μs pulse, $T_j = 25^\circ\text{C}$		450		mA
		$V_{DS} = 80\text{V}$, $V_{GS} = 5\text{V}$ 2 μs pulse, $T_j = 225^\circ\text{C}$		300		mA

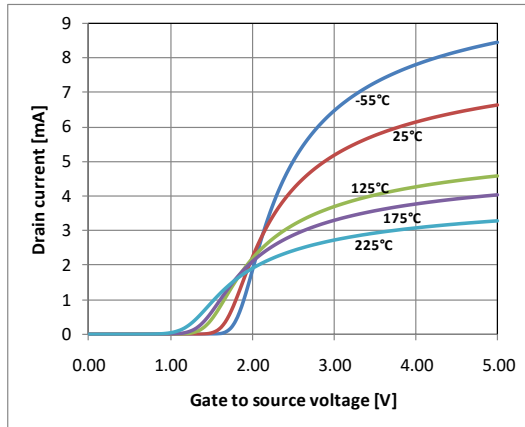
Thermal Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Thermal resistance (junction to case, TO-18 package)	Θ_{JC}			60		$^\circ\text{C/W}$

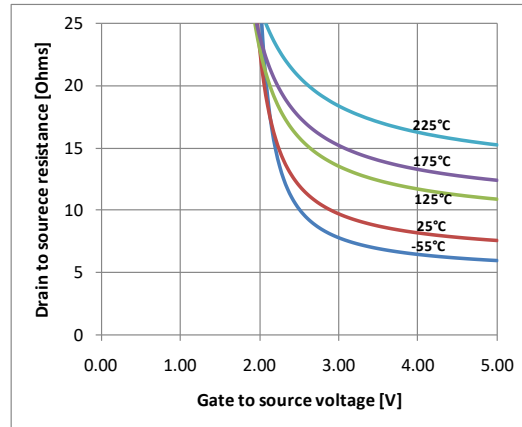
¹ Includes ESD diode leakage current.

² Voltage for which the cut-off current evolution versus V_{DS} becomes exponential.

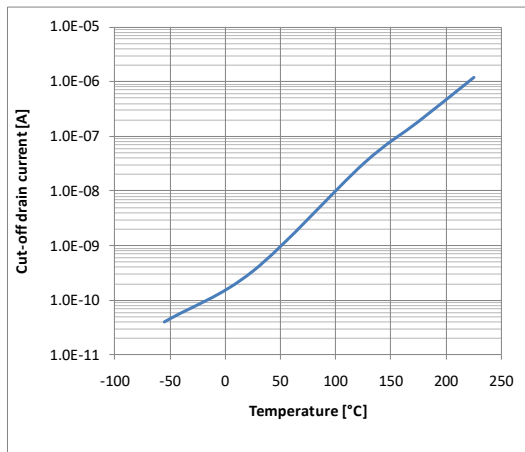
Typical Performance Characteristics



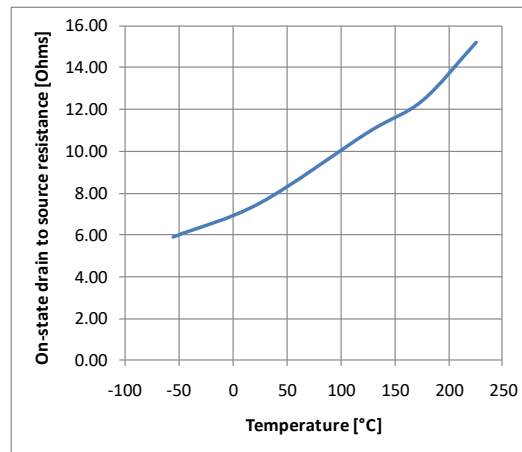
Drain current vs. gate-source voltage ($V_D=50mV$).



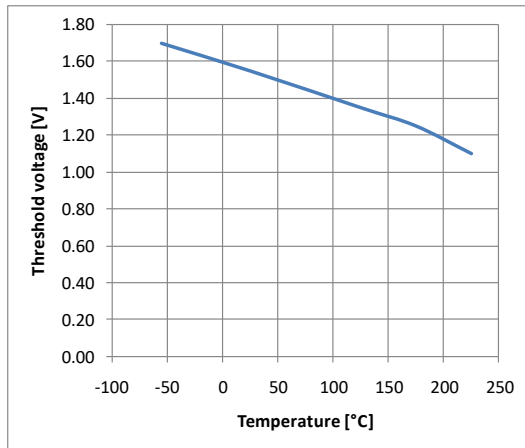
Drain source resistance vs. gate-source voltage ($V_D=50mV$).



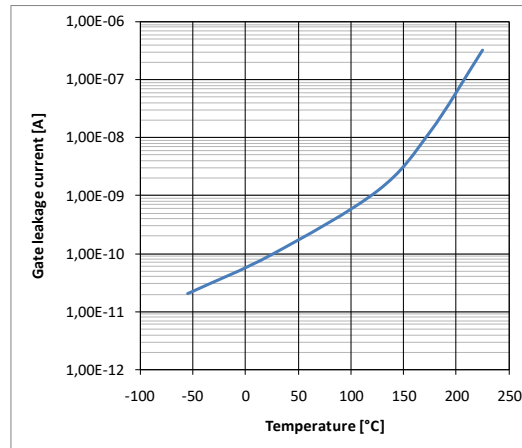
Cut-off drain current vs. temperature ($V_G=0V$, $V_D=80V$).



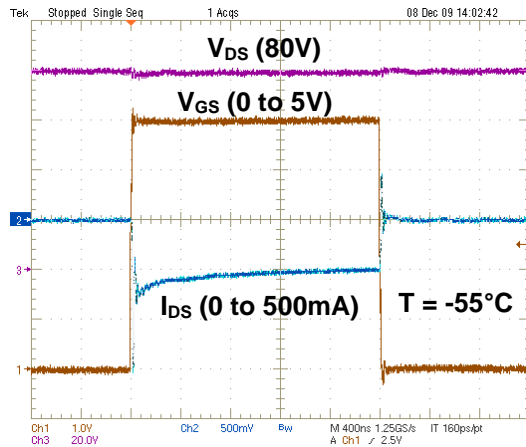
On-state drain source resistance vs. temperature ($V_G=5V$, $V_D=50mV$).



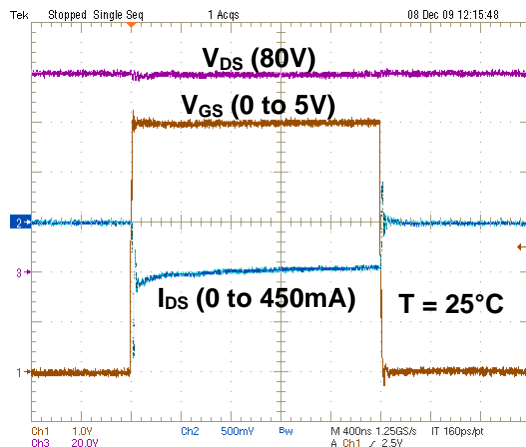
Threshold voltage vs. temperature.



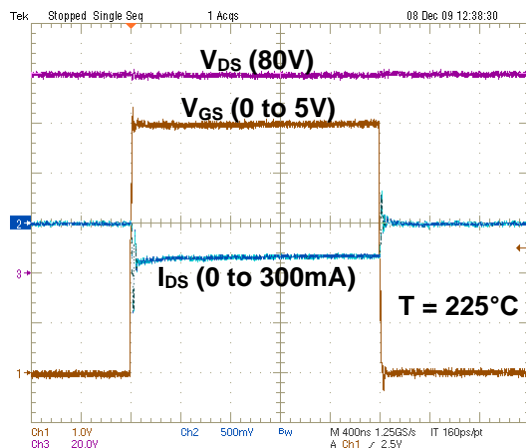
Gate and ESD diode leakage current vs. temperature ($V_G=5V$, $V_D=50mV$).



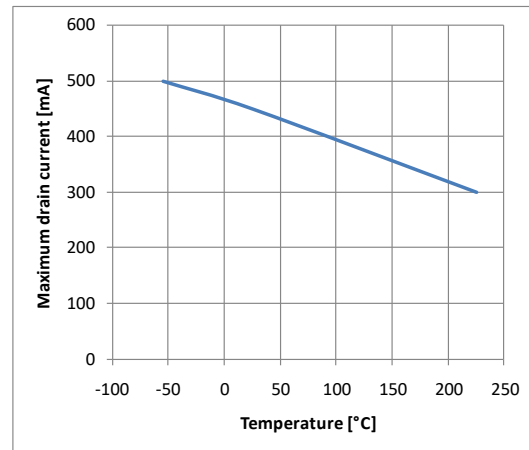
Maximum drain current pulse test (T=-55°C).



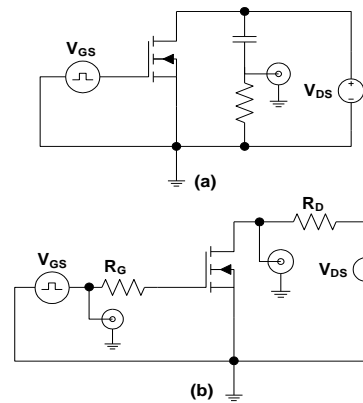
Maximum drain current pulse test (T=25°C).



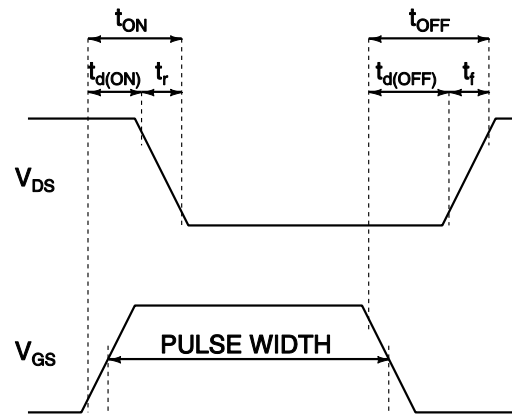
Maximum drain current pulse test (T=225°C).



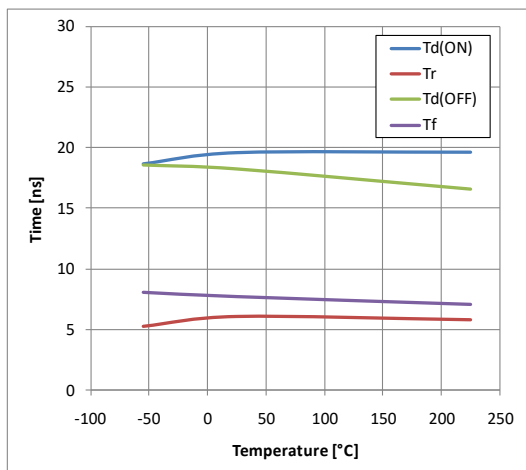
Peak drain current vs. temperature (V_G=5V, V_D=80V).



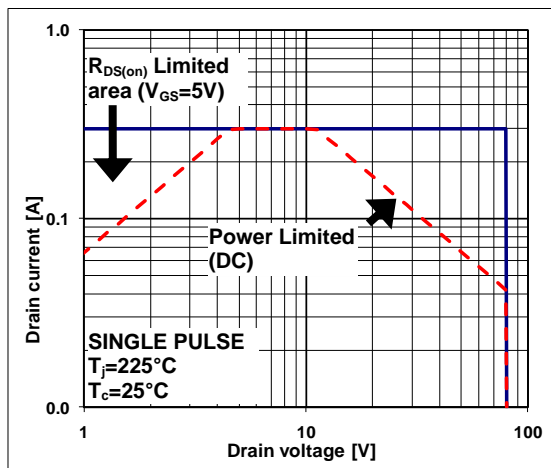
(a) I_D^{MAX} measurement scheme $R=1\Omega$, $C=100\mu F$, Compliance ($V_{DS}=80V$)=100mA (b) Timing measurement scheme $R_G=0\Omega$, $R_D=82\Omega$, $V_{DS}=40V$.



Timing definition diagram.



Timing parameters versus temperature.



Forward bias safe operating area

Application Note: CHT-SNMOS80 used as a diode

General description

CHT-SNMOS80 can be used as high temperature general purpose diode able to sustain reverse voltages of up to 80V. The typical operation temperature range goes from -55°C to 225°C.

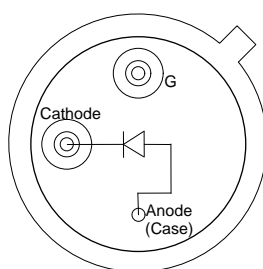
Applications

Rectification, voltage blocking, general purpose switching.

Features

- Qualified from -55 to +225°C (Tj)
- Operational up to +250°C (Tj)
- Reverse voltage up to 80V
- Forward surge current 200mA @ 225°C
- Low reverse leakage current 4 µA @ 225°C
- Available in TO18 package (other packages available upon request).

Package configuration



TO18 (Top view)

G pin to be connected to Anode externally!

Absolute Maximum Ratings

Reverse voltage V_R	80V
Forward surge current I_{FSM}	200mA
Power dissipation $T_c=25^\circ\text{C}$	300mW
Junction temperature T_j	300°C

Operating Conditions

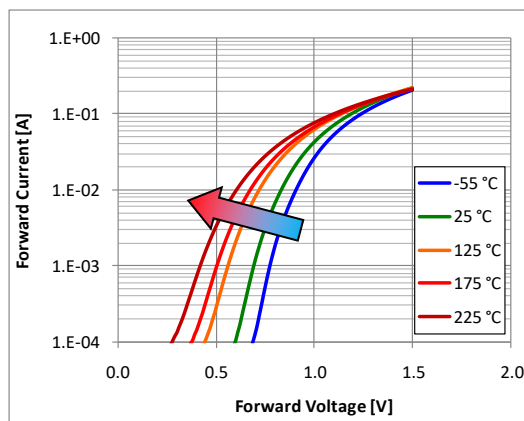
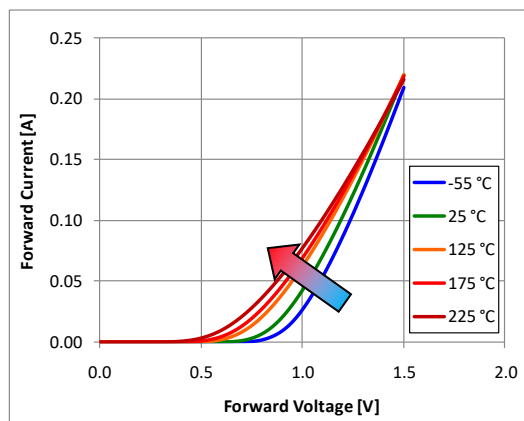
Reverse voltage V_R	0V to 80V
Continuous forward current I_F	0mA to 150mA
Forward voltage V_F	0V to 1.25V
Power dissipation $T_c=25^\circ\text{C}$	200mW
Junction temperature	-55°C to +225°C

Electrical characteristics

Unless otherwise stated, $T_j = 25^\circ\text{C}$. **Bold** figures point out values valid over the whole temperature range ($T_j = -55^\circ\text{C}$ to $+225^\circ\text{C}$).

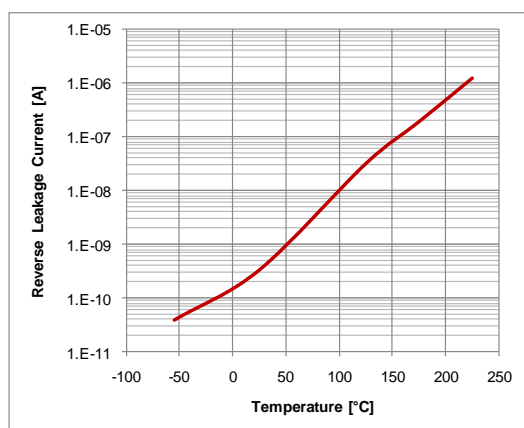
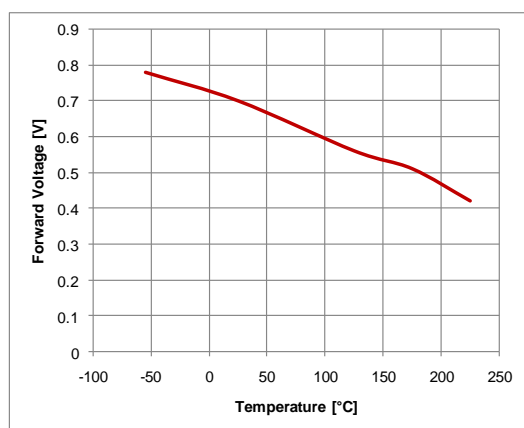
Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward voltage	V_F	$I_F=1\text{mA}$, $T_j=25^\circ\text{C}$		0.7		V
Forward surge current	I_{FSM}				200	mA
Reverse leakage current	I_{RM}	$V_R=80\text{V}$, $T_j=25^\circ\text{C}$		5		nA
		$V_R=80\text{V}$, $T_j=225^\circ\text{C}$		4		uA
Breakdown reverse voltage	V_R		80			V
Junction capacitance	C_j	$V_R=25\text{V}$		8.6		pF

Typical Performance Characteristics



Forward current vs. forward voltage and temperature (linear scale).

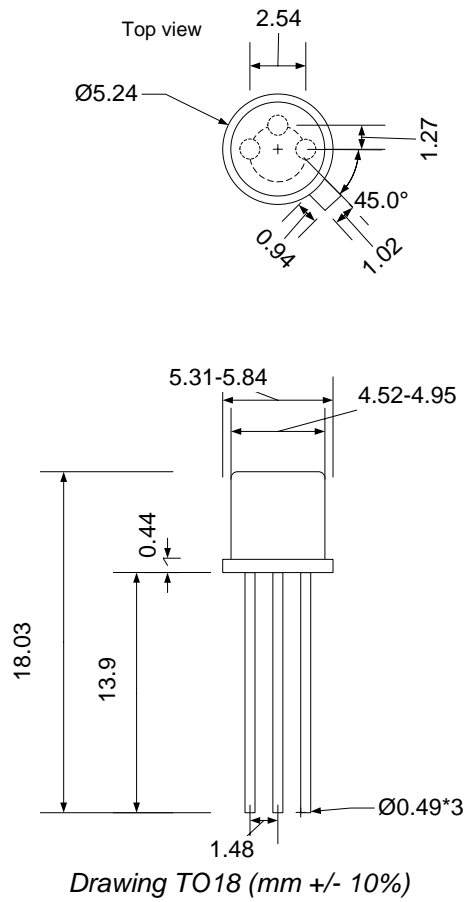
Forward current vs. forward voltage and temperature (\log_{10} scale).



Forward voltage (at forward current $I_F=1\text{mA}$) vs. temperature.

Reverse leakage current (at reverse voltage $V_R=80\text{V}$) vs. temperature.

Package Dimensions



Ordering Information

Ordering Reference	Package	Temperature Range	Marking
CHT-SNMOS80-TO18-T	TO-18 metal can	-55°C to +225°C	CHT-SN8

Contact & Ordering

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